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Connected Factory Exchange (CFX)

Developed by the IPC-CFX Standard Task Group (2-17a) of the Electronic Product Data Description Committee (2-10) of IPC

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Users of this publication are encouraged to participate in the development of future revisions.

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1 SCOPE

This standard establishes the requirements for the omnidirectional exchange of information between manufacturing processes and associated host systems for assembly manufacturing. This standard applies to communication between all executable processes in the manufacture of printed board assemblies – automated, semiautomated and manual – and is applicable to related mechanical assembly and transactional processes.

1.1 Purpose With the growth and acceptance of digital modeling and practices in manufacturing, the lack of a holistic Industrial Internet of Things (IIoT) standard for the transfer of information between machines, systems and processes has become a severe limitation to the growth of digitization and computerization in the electronics manufacturing industry, inhibiting technology innovations such as Industry 4.0 and Smart Factories being available to all companies in the industry, regardless of size, sector and location.

This Connected Factory Exchange (CFX) standard provides a true ‘‘plug and play’’ Internet of Things (IoT) communication environment throughout manufacturing, where all equipment, manufacturing processes and transactional stations can communicate with each other without the need for the development and use of bespoke interfaces. CFX-enabled equipment and solutions from different vendors work seamlessly together.

There are many types of users of this CFX standard, including equipment vendors, solution providers, in-house information technology (IT) groups, etc. The many types of data included in CFX are used in different ways depending on the application; for example, closed-loop feedback systems, live production dashboards, traceability (IPC-1782), manufacturing execution systems (MES) control, lean supply chain management, active quality management, production control, etc.

As CFX data is fully omnidirectional, any CFX endpoint connection can consume data as well as create it. As an illustration, consider the scenario in which a single machine from a certain vendor is connected in-line with other machines from different vendors. CFX messages are sent from the single machine to other machines in the line, and to host systems such as MES. The single machine can also receive CFX messages from all other machines in the line, as well as from the host systems in order to optimize the machine operation and enable the vendor of the machines to create added-value functionality, such as to support machine-specific Industry 4.0. In this way, a smart, digital, Industry 4.0 factory will be comprised of many different Industry 4.0 computerization applications, each of which can be provided by different suppliers, at the machine, line, site and even enterprise levels, all working together, sharing data seamlessly through CFX.

This CFX standard supports the concept of big data by including data of different types from across the factory, including performance, materials, resources, users, quality events, product tracking, etc., all of which can be combined to create a big-data environment. CFX, therefore, provides many kinds of added value opportunities to the whole manufacturing operation, including, for example, improving operational efficiency and productivity, quality and reliability, agility and responsiveness. This CFX standard helps organizations ensure that end users/consumers will receive products and services that meet or exceed their expectations and in the timeliest and most economically viable method.

1.2 Application of This Standard This standard defines the communication protocol and content across all assembly production processes, irrespective of type or method of operation. It can also be applied to transactional operations. There are no restrictions in terms of product classification sector, size of operation or location. Surface-mount technology (SMT) production is not required to be a part of the factory. Though intended to support all aspects of printed board production, the use of CFX can be extended downstream to include, for example, mechanical assembly, personalization, packing and shipping, as well as upstream to include, for example, electrical and mechanical subassemblies.

1.3 CFX and The Hermes Standard This CFX standard is complementary to IPC-HERMES-9852. The Hermes Standard, as an advanced, intelligent Surface Mount Equipment Manufacturers Association (SMEMA) standard replacement, provides near-instant line control, passing information about production units as they pass down the line. CFX provides vertical messaging that is complementary to Hermes.

1.4 Updates to This Standard The IPC-CFX Standard Task Group intends to make frequent incremental revisions to this standard to support additional machines and processes. Version updates are identified by version number and the change (added, removed, etc.), so the reader can easily identify changes in each version. See Figure 1-1 for an example of this version change tracking using a portion of the CFX.Materials.Management table of this standard as an example.

Appendix A also provides an itemized version history.